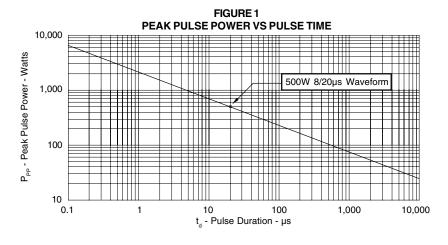
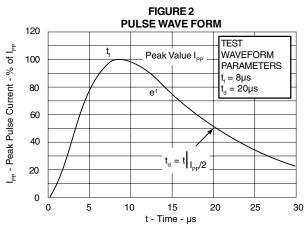
DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified									
PARAMETER	SYMBOL	VALUE	UNITS						
Peak Pulse Power (tp = 8/20μs) - See Fig. 1	P_{PP}	600	Watts						
Peak Pulse Current (tp = 8/20μs)	l _{PP}	30	Amps						
Lead Soldering Temperature	I _{FRM}	260	℃						
Operating Temperature	T _L	-55 to 150	∞						
Storage Temperature	T _{stg}	-55 to 150	°C						

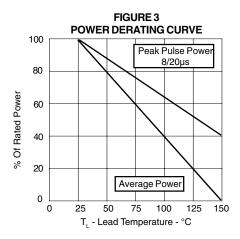
ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified											
PART NUMBER	DEVICE MARKING	RATED STAND-OFF VOLTAGE (See Note 1)	MINIMUM BREAKDOWN VOLTAGE (See Note 1)	MINIMUM SNAPBACK VOLTAGE (See Note 1)	MAXIMUM CLAMPING VOLTAGE (See Note 1) (See Fig. 2)				MAXIMUM LEAKAGE CURRENT (See Note 1)	TYPICAL CAPACITANCE (See Note 1)	
		V _{wm} VOLTS	@ 1mA V _(BR) VOLTS	@I _{SB} = 50mA V _{SB} VOLTS	@I _{PP} = 2A V _c VOLTS	@I _{PP} =5A V _C VOLTS	@I _{PP} = 24A V _C VOLTS	@I _{PP} = 30A V _C VOLTS	@V _{wм} Ι _D μΑ	@0V, 1MHz C pF	
SLVU2.8-8	SL8	2.8	3.0	2.8	5.5	8.5	15	17	1.0	6	

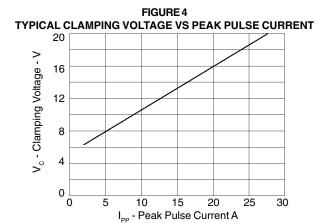
Note 1: Device measured between pin 1 to 2, pin 3 to 4, pin 5 to 6 and pin 7 to 8.





GRAPHS





APPLICATION NOTE

Electronic equipment is susceptible to damage caused by Electrostatic Discharge (ESD), Electrical Fast Transients (EFT), and tertiary lightning effects. Knowing that equipment can be damaged, the SLVU2.8-8 was designed to provide the level of protection required to safe guard sensitive equipment. This product can be used in different configurations to provide a level of protection to meet bidirectional requirements either in a common-mode or differential-mode configuration.

BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)

The SLVU2.8-8 provides up to four lines of protection in a common-mode configuration as depicted in figure 1.

Circuit connectivity is as follows:

- ✓ Line 1 is connected to Pin 1
- ✓ Line 2 is connected to Pin 8
- ✓ Line 3 is connected to Pin 5
- ✓ Line 4 is connected to Pin 4
- ✔ Pins 2, 3, 6 and 7 are connected to ground

BIDIRECTIONAL DIFFERENTIAL-MODE CONFIGURATION (Figure 2)

The SLVU2.8-8 provides up to four line paris of protection in a differential-mode configuration as depicted in figure 2.

Circuit connectivity is as follows:

- ✓ Line Pair 1 is connected to Pins 1 & 2
- ✓ Line Pair 2 is connected to Pins 3 & 4
- ✓ Line Pair 3 is connected to Pins 7 & 8
- ✓ Line Pair 4 is connected to Pins 5 & 6

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

Figure 1. Bidirectional Common-Mode Protection

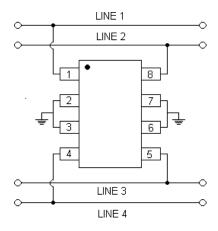
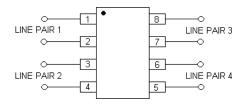
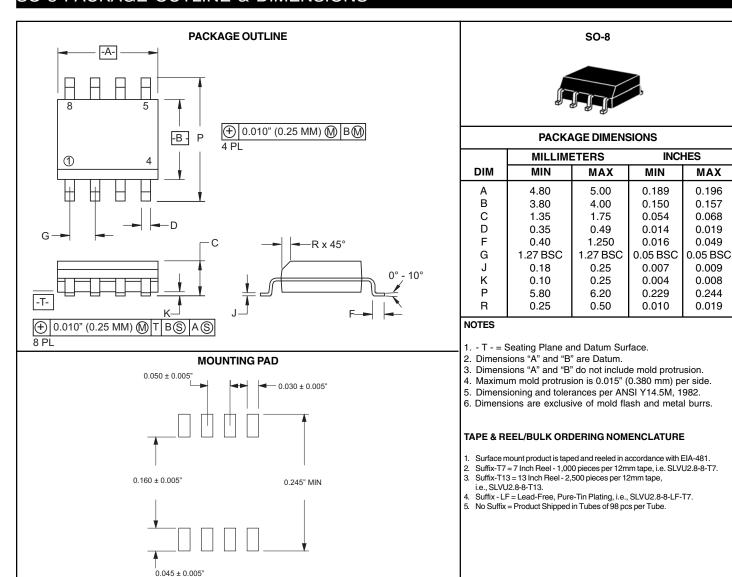


Figure 2. Bidirectional Differential-Mode Protection



SO-8 PACKAGE OUTLINE & DIMENSIONS



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ProTek Devices

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